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Doc. No. 52175

VIA FACSIMILE

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:)	
Tai-Chong CH	AI et al.) Date: May 17, 2002) Group Art Unit: 2815	touch
Serial No.:	09/497,421	1 /1/1	Chille
Filed:	February 2, 2000) Examiner: L. Cruz	16/02

LEAD FRAME FOR AN INTEGRATED CIRCUIT CHIP (SMALL WINDOW) COPY RECEIVED

Assistant Commissioner for Patents Washington, D.C. 20231

MAY 17 2002

TECHNOLOGY CENTER 2800

(NE) #17/C T.BELL 5.29:02

Sir:

AMENDMENT AFTER FINAL REJECTION

In response to the Office Action of January 22, 2002, please amend the claims as follows.

IN THE CLAIMS

1 1. (Three times Amended) A lead frame, for an integrated circuit chip having a 2 frame engaging bottom surface for attachment to the frame by means of a chip attach material, said chip being formed with outer edges having defined dimensions, said frame comprising: 3 5 a unitary apertured frame having a central through aperture therein including a plurality of [unitary] uniform sidebars each having an upper chip-supporting surface for engaging the 6 bottom of the surface of the chip with the chip attach material therebetween, 7 8 9 each of said sidebars having an inner [side] edge and an outer [side] edge, said inner 10 [sides] edges defining [an] the central aperture,

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